Amendments to the Claims

Please amend the claims as follows:

(Currently Amended) An input device comprising:
an electrostatic-capacitance-type input sensor including a flexible substrate;
a plurality of X electrodes that are formed on the flexible substrate and that are
disposed on an insulating layer and a plurality of Y electrodes that are disposed on an
insulating layer; and

an extension section that is extended from the flexible substrate,

wherein the X and Y electrodes are connected to a circuit substrate provided in the extension section, and a reverse surface of the flexible substrate on which the X and Y electrodes are not formed is bonded along a rear surface of a curved portion of an insulating support plate. the electrodes are bonded to a rear surface of an insulating support plate that supports the input sensor, and the circuit substrate is bonded to the insulating support plate.

- 2. (Original) An electrostatic-capacitance-type coordinate input device according to Claim 1, wherein a recess to which the input sensor is fitted is formed on the rear surface of said support plate at a position where said input sensor is bonded.
- 3. (Previously Presented) An electrostatic-capacitance-type coordinate input device according to Claim 1, wherein a pointing section for pointing a position of said input sensor is formed in said support plate.
 - 4. 7. (Cancelled)

8. (Currently Amended) A device, comprising;

an input device having a coordinate-input sensor formed on a flexible substrate and having an electrode layer for detecting electrostatic capacitance;

. . . .

a device housing having an insulating portion having obverse and reverse sides, the obverse side being exposed;

wherein the input sensor is disposed on the reverse side of the insulating portion and an input operation is performable at the obverse side, and

wherein the coordinate-input sensor has an extension section, the extension section is provided with a circuit substrate to which the electrodes are connected, the input sensor is bonded around a support plate of a curved surface, and the circuit substrate is bonded to a support plate of a planar surface, and

wherein the input device includes a single flexible substrate, and a reverse surface of the flexible substrate on which X and Y electrodes are not formed is bonded along a rear surface of a curved portion of an insulating support plate.

- 9. (Previously Presented) The device according to claim 8, wherein the input sensor is bonded to an arcuate section formed in the insulating portion.
- 10. (Previously Presented) The device according to claim 8, wherein the input sensor is bonded to a recessed area formed in the reverse side.
- 11. (New) An electrostatic-capacitance-type coordinate input device according to Claim 1, wherein the reverse surface of the flexible substrate corresponding to the extension section is bonded to a rear surface of a planar portion of the insulating support plate.
- 12. (New) The device according to claim 8, wherein the reverse surface of the flexible substrate corresponding to the extension section is bonded to a rear surface of a planar portion of the insulating support plate